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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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DATA SHEET



SILICON POWER TRANSISTOR 2SC4815

NPN SILICON EPITAXIAL TRANSISTOR FOR HIGH-SPEED SWITCHING

The 2SC4815 is a power transistor developed for high-speed switching and features low $V_{CE(sat)}$ and high here. This transistor is ideal for use as a driver in DC/DC converters and actuators.

In addition, this transistor is available for the auto mount in the radial taping specifications and for mounting cost reduction.

FEATURES

• High hFE and low VCE(sat):

 $V_{\text{CE(sat)}} \leq 0.3 \text{ V} \quad @ \text{Ic} = 3.0 \text{ A}, \text{ Ib} = 0.15 \text{ A}$

 $h_{\text{FE}} \geq 100 \qquad \qquad @V_{\text{CE}} = 2.0 \text{ V}, \text{ Ic} = 1.0 \text{ A}$

Available for auto mount in radial taping specifications

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	Vсво	100	V
Collector to emitter voltage	VCEO	60	v
Emitter to base voltage	Vebo	7.0	v
Collector current (DC)	IC(DC)	5.0	А
Collector current (pulse)	C(pulse)*	10	А
Base current (DC)	B(DC)	2.5	А
Total power dissipation	Рт	1.8	w
Junction temperature	Tj	150	°C
Storage temperature	Tstg	–55 to +150	°C

* PW \leq 300 μ s, duty cycle \leq 10%

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Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector to emitter voltage	VCEO(SUS)	Ic = 5.0 A, I _B = 0.5 A, L = 1 mH	60			V
Collector to emitter voltage	VCEX(SUS)	Ic = 2.5 A, I _{B1} = $-I_{B2}$ = 0.25 A V _{BE(OFF)} = -1.5 V, L = 180 μ H, Clamped	60			V
Collector cutoff current	Ісво	$V_{CB} = 100 V, I_E = 0$			10	μA
Emitter cutoff current	Іево	V _{EB} = 7.0 V, Ic = 0			10	μA
DC current gain	hfe1*	Vce = 2.0 V, Ic = 0.5 A	100			
DC current gain	hFE2*	Vce = 2.0 V, Ic = 1.0 A	100	200	400	
DC current gain	hfe3*	Vce = 2.0 V, Ic = 3.0 A	60			
Collector saturation voltage	V _{CE(sat)1} *	Ic = 3.0 A, Iв = 0.15 A		0.15	0.3	V
Collector saturation voltage	VCE(sat)2*	Ic = 4.0 A, I _B = 0.2 A		0.3	0.5	V
Base saturation voltage	VBE(sat)1*	Ic = 3.0 A, I _B = 0.15 A		0.9	1.2	V
Base saturation voltage	VBE(sat)2*	Ic = 4.0 A, I _B = 0.2 A		1.2	1.5	V
Collector capacitance	Cob	V_{CB} = 10 V, I_{E} = 0 , f = 1.0 MHz		70		pF
Gain bandwidth product	fт	$V_{CE} = 10 \text{ V}, \text{ Ic} = 0.5 \text{ A}$		150		MHz
Turn-on time	ton	$\text{Ic}=3.0\text{ A},\text{ R}_{\text{L}}=17\ \Omega,$		0.1		μs
Storage time	tstg	I _{B1} = −I _{B2} = 0.15 A, Vcc ≅ 50 V Refer to the test circuit.		1.0		μs
Fall time	tr			0.25		μs

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

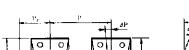
* Pulse test PW \leq 350 μ s, duty cycle \leq 2%

hfe CLASSIFICATION

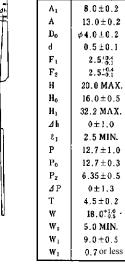
Marking	М	L	к
hFE2	100 to 200	150 to 300	200 to 400

PACKAGE DRAWING (UNIT: mm)

Electrode Connection 1. Base 2. Collector 3. Emitter



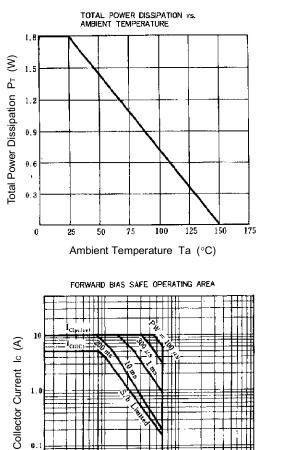
TAPING SPECIFICATION



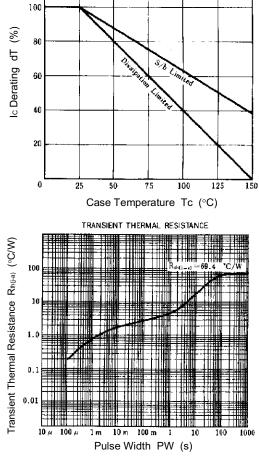
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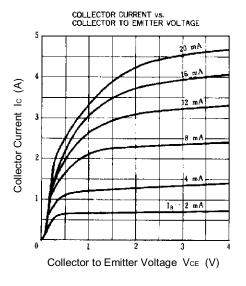
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TYPICAL CHARACTERISTICS (Ta = 25°C)



DERATING CURVE OF SAFE OPERATING AREA



O.

10

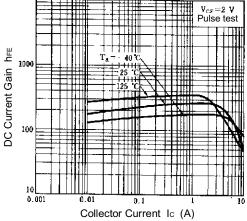
10

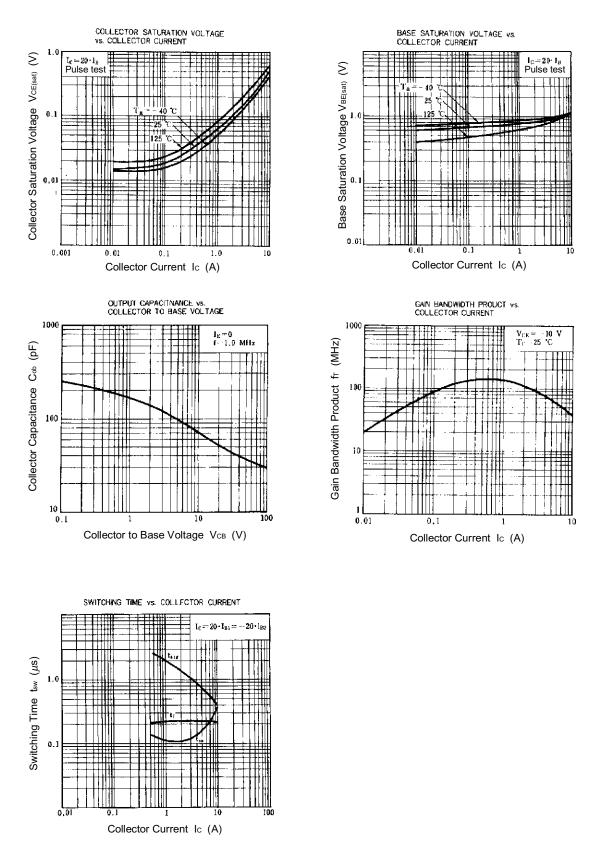
Collector to Emitter Voltage VCE (V)

Single pulse

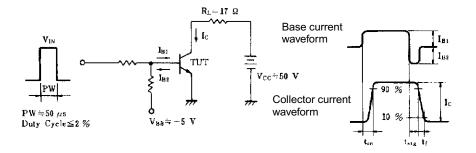
T_c - 25 °C

> DC CURRENT GAIN VS. COLLECTOR CURRENT





SWITCHING TIME (ton, tstg, tf) TEST CIRCUIT



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